

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Daniel F. Sievenpiper,)	Re: Preliminary Amendment
et al.)	
)	
Serial No.: Not yet assigned)	
Filed: concurrently herewith)	
)	
Divisional of USSN 09/905,794)	
filed on July 13, 2001)	Our Ref: B-4046DIV 621280-9
)	
For: "MOLDED HIGH IMPEDANCE SURFACE)	
AND A METHOD OF MAKING SAME")	Date: December 5, 2003

PRELIMINARY AMENDMENT

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The above-identified application is a divisional of pending prior U.S. Patent Application Serial No. 09/905,794 filed on July 13, 2001. This paper is being filed as a Preliminary Amendment to the above-identified Application being filed concurrently herewith. Please amend the above-identified application as described below. **All amendments and remarks herein are made without prejudice.**

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims begin on page 3 of this paper.

Amendments to the Drawings begin on page 6 of this paper and include an attached replacement sheet.

Remarks/Arguments begin on page 7 of this paper.